## COMBINED DECLARATION AND POWER OF ATTORNEY

As a below named inventor, I hereby declare that:

My residence, post office address and citizenship are as stated below next to my name,

I believe I am the original, first and sole inventor (if only one name is listed below) or an original, first and joint inventor (if plural names are listed below) of the subject matter which is claimed and for which a patent is sought on the invention entitled <u>SEMICONDUCTOR DEVICE AND METHOD OF DRIVING SEMICONDUCTOR DEVICE</u>, the specification of which:

| []  | is attached hereto.  |  |  |  |  |  |
|---|--|--|--|--|--|--|
| []  | was filed on   | as Application :   | Serial No and was  |  |  |  |
|   | amended on   |  |  |  |  |  |
| []  | was described and claimed  | was described and claimed in PCT International Application No filed  |  |  |  |  |
|   | on   | and as amended under PCT   | Article 19 on  |  |  |  |
|   | eby state that I have reviewed<br>amended by any amendment   |  | bove-identified specification, including   |  |  |  |
|   | knowledge the duty to disclose of Federal Regulations, §1.   |  | rial to patentability in accordance with   |  |  |  |
| I hereby claim the benefit under Title 35, United States Code, §119(e)(1) of any United States provisional application(s) listed below: |  |  |  |  |  |  |
|   | U.S. Serial No.  | Filing Date  | Status   |  |  |  |
| below and, in   | sofar as the subject matter of   | each of the claims of this applicatio  | f any United States application(s) listed in is not disclosed in the prior United  |  |  |  |
| below and, in<br>States applica<br>the duty to dis<br>Regulations,  | sofar as the subject matter of<br>tion in the manner provided<br>sclose all information I know   | Feach of the claims of this application by the first paragraph of Title 35, Unit to be material to patentability as detable between the filing date of the price.  | n is not disclosed in the prior United nited States Code, §112, I acknowledge  |  |  |  |
| below and, in<br>States applica<br>the duty to dis<br>Regulations,  | sofar as the subject matter of<br>tion in the manner provided<br>sclose all information I know<br>§1.56(a) which became avails   | each of the claims of this application by the first paragraph of Title 35, Universe to be material to patentability as detable between the filing date of the pr   | n is not disclosed in the prior United<br>hited States Code, §112, I acknowledge<br>fined in Title 37, Code of Federal   |  |  |  |
| I her for patent or i the United States of Ame priority is cla  | sofar as the subject matter of ation in the manner provided sclose all information I know §1.56(a) which became availabiling date of this application  U.S. Serial No.  The by claim foreign priority beinventor's certificate or of any ates of America listed below the tificate or any PCT international priority in the same imed:                             | reach of the claims of this application by the first paragraph of Title 35, United between the filing date of the presence of  | n is not disclosed in the prior United nited States Code, §112, I acknowledge fined in Title 37, Code of Federal ior application and the national or PCT  Status  Code, §119 of any foreign application(s) signating at least one country other than foreign application for patent or ast one country other than the United efore that of the application(s) of which |  |  |  |
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## **Combined Declaration and Power of Attorney**

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I hereby appoint the following attorneys and/or agents to prosecute this application and to transact all business in the Patent and Trademark Office connected therewith:

John F. Hayden, Reg. No. 37,640; Scott C. Harris, Reg. No. 32,030; Michael McKeon, Reg. No. 37,888; Linda Liu Kordziel, Reg. No. 39,732; William E. Booth, Reg. No. 28,933; Ruffin B. Cordell, Reg. No. 33,487; John W. Freeman, Reg. No. 29,066; Timothy A. French, Reg. No. 30,175; G. Roger Lee, Reg. No. 28,963; Ralph A. Mittelberger, Reg. No. 33,195; John B. Pegram, Reg. No. 25,198; Rene D. Tegtmeyer, Reg. No. 33,567; Charles C. Winchester, Reg. No. 21,040; William D. Hare, Reg. No. 44,739; James E. Mrose, Reg. No. 33,264; Lauren A. Degnan, Reg. No. 40,584; Andrew F. Bodendorf, Reg. No. 39,537; Robert V. Racunas, Jr., Reg. No. 43,027; Diana DiBerardino, Reg. No. 45,653; W. Karl Renner, Reg. No. 41,265; Joseph F. Key, Reg. No. 44,827; Harold H. Fox, Reg. No. 41,498; Scott R. Boalick, Reg. No. 42,337; Joseph V. Colaianni, Jr., Reg. No. 39,948; Gregory A. Walters, Reg. No. 41,366; R. Whitney Winston, Reg. No. 44,432; Bing Ai, Reg. No. 43,312; N. Thane Bauz, Reg. No. 41,604; Robert Bedgood, Ph.D., Reg. No.43,488; Gregory P. Einhorn, Reg. No. 38,440; Diane L. Gardner, Reg. No. 36,518; James T. Hagler, Reg. No. 40,631; Kenyon S. Jenckes, Reg. No. 41,873; Samuel S. Lee, Reg. No. 42,791; Christopher S. Marchese, Reg. No. 37,177; Todd G. Miller, Reg. No. 42,003; Shekhar Vyas, Reg. No. 46,166; and John R. Wetherell, Jr., Ph.D., Reg. No. 31,678.

Address all telephone calls to John F. Hayden at telephone number (202) 783-5070.

Address all correspondence to John F. Hayden at:

Shigeru ONOYA

FISH & RICHARDSON P.C. 601 Thirteenth St., N.W. Washington, DC 20005

Full Name of Inventor:

I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and that such willful false statements may jeopardize the validity of the application or any patents issued thereon.

| Inventor's Signature:  | Shigeru Onoya                                      | Date: | 01/29/2001 |
|------------------------|--|-------|------------|
| Residence Address:     | Kanagawa, Japan                                    |       |            |
| Citizenship:           | Japanese   |       |            |
| Post Office Address:   | C/O Semiconductor Energy Laboratory Co., Ltd.      |       |            |
|                        | 398, Hase, Atsugi-shi, Kanagawa-ken 243-0036 Japan |       |            |
| Full Name of Inventor: |  |       |            |
| Inventor's Signature:  |  | Date: |            |
| Residence Address:     |  | _     |            |
| Citizenship:           |  |       |            |
| Post Office Address:   |  |       |            |
| Full Name of Inventor: |  |       |            |
| Inventor's Signature:  |  | Date: |            |
| Residence Address:     |  | _     |            |
| Citizenship:           |  |       |            |
| Post Office Address:   |  |       |            |